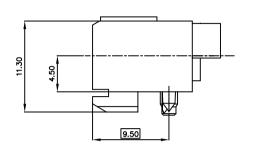
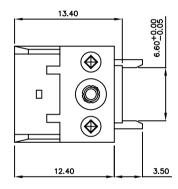


1 | 2









- 1. PCB LAYOUT IS SHOWN FOR HOUSINGR EQUIREMENTS ONLY.
- 2. INDICATED HOLES ARE TO BE UNPLATED 3.THIS PRODUCT WITH "LF" SUFFIX MEETS EURPOEAN UNIONDIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS -22-008.
- 4.THE HOUSING WILL WITHSTAND EXPOSURE TO 260 DEGREE PEAK TEMPERATURE FOR 20 SECONDS IN WAVE SOLDER APPLICATION WITH A 1.6 MM MINIUM THICK CIRCUIT BOARD.

mat'l. code ———						tolerances unless otherwise specified						CUSTOMER					4						
ltr	ecn n	n no dr		date				.X ±.3				COPY			FCI				www.fciconnect.cor				om
Α	V2161	18	CGD	10/1	0/02	linea	r 🗌	.XX ±		:.13		proje	ectior	1	title)	/ .			
В	B2016	B20167 GNY		021	015			£ XXX.		±.051		A -1		_	MŁ		AL_	.K/	Ά	CO	AX.	_	
С	DG05-0	372	CLu 05		007	angle	es	0° ±2°			Z V		RECEPTACLÉ					<u>HOUSING</u>					
						dr	0	C. DAILY M. GRAY		10/10/02					uct fa		М	IETR,	AL		code	е	
						engr				10/10/	0/02	-			size	dwg	no					2	213
						chr		M. GRAY		10/10/		scale			۱,		7	$2 - \frac{1}{2}$	2718			shee	et
						appd	N	M. GRAY		10/10/02		1:1			Α		/	<i>Z /</i>				1 0	of 1
she	et re	revision		C																			
index		sheet		1																			



All rights strictly reserved. Reproduction or issue to form whotever is not permitted without written authori-Property of FCI. Copyright FCI.

1 | 2

3±0.15

RECOMMENDED HOLE PATTERN, COMPONENT SIDE. NOTE 1

SEE NOTE 2

ACAT

PDM: Rev:C

STATUS: Released

Printed. Nov 29, 2007